ELECTRONIC HEADSET COUPLING MECHANISM

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381/322, 328; 379/430, 431, 433.05;
D11/222, 228; 24/113 R, 113 MP

See application file for complete search history.

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CLAIM

The ornamental design for an electronic headset coupling mechanism, as shown and described.

DESCRIPTION

FIG. 1 is a bottom side perspective view of an electronic headset coupling mechanism that is arranged and configured in accordance with one embodiment;
FIG. 2 is a bottom view of the electronic headset coupling mechanism of FIG. 1;
FIG. 3 is a top view of the electronic headset coupling mechanism of FIG. 1;
FIG. 4 is a front view of the electronic headset coupling mechanism of FIG. 1;
FIG. 5 is a rear view of the electronic headset coupling mechanism of FIG. 1;
FIG. 6 is a left side view of the electronic headset coupling mechanism of FIG. 1;
FIG. 7 is a right side view of the electronic headset coupling mechanism of FIG. 1;
FIG. 8 is a bottom perspective view of the electronic headset housing of FIG. 1.
FIG. 9 is a right side cross section view of the electronic headset coupling mechanism of FIG. 1.
FIG. 10 is a bottom view of an electronic headset coupling mechanism that is arranged and configured in accordance with a second embodiment;
FIG. 11 is a left side view of the electronic headset coupling mechanism of FIG. 10;
FIG. 12 is a front view of the electronic headset coupling mechanism of FIG. 10; and,
FIG. 13 is a front bottom perspective view of the electronic headset coupling mechanism of FIG. 10.

1 Claim, 10 Drawing Sheets
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